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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	3537
Number of Logic Elements/Cells	75000
Total RAM Bits	8666112
Number of I/O	336
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/5agxba1d4f27i5n">https://www.e-xfl.com/product-detail/intel/5agxba1d4f27i5n</a>

Symbol	Description	Minimum <sup>(5)</sup>	Typical	Maximum <sup>(5)</sup>	Unit
V <sub>CCL_GXBL</sub>	GX and SX speed grades—clock network power (left side)	1.08/1.12	1.1/1.15 <sup>(6)</sup>	1.14/1.18	V
V <sub>CCL_GXBR</sub>	GX and SX speed grades—clock network power (right side)				
V <sub>CCL_GXBL</sub>	GT and ST speed grades—clock network power (left side)	1.17	1.20	1.23	V
V <sub>CCL_GXBR</sub>	GT and ST speed grades—clock network power (right side)				

**Related Information****Arria V GT, GX, ST, and SX Device Family Pin Connection Guidelines**

Provides more information about the power supply connection for different data rates.

**HPS Power Supply Operating Conditions****Table 1-5: HPS Power Supply Operating Conditions for Arria V SX and ST Devices**

This table lists the steady-state voltage and current values expected from Arria V system-on-a-chip (SoC) devices with ARM®-based hard processor system (HPS). Power supply ramps must all be strictly monotonic, without plateaus. Refer to Recommended Operating Conditions for Arria V Devices table for the steady-state voltage values expected from the FPGA portion of the Arria V SoC devices.

Symbol	Description	Condition	Minimum <sup>(7)</sup>	Typical	Maximum <sup>(7)</sup>	Unit
V <sub>CC_HPS</sub>	HPS core voltage and periphery circuitry power supply	–C4, –I5, –C5, –C6	1.07	1.1	1.13	V
		–I3	1.12	1.15	1.18	V

<sup>(5)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(7)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Symbol	Description	Condition (V)	Calibration Accuracy			Unit
			-I3, -C4	-I5, -C5	-C6	
60- $\Omega$ and 120- $\Omega$ R <sub>T</sub>	Internal parallel termination with calibration (60- $\Omega$ and 120- $\Omega$ setting)	V <sub>CCIO</sub> = 1.2	-10 to +40	-10 to +40	-10 to +40	%
25- $\Omega$ R <sub>S_left_shift</sub>	Internal left shift series termination with calibration (25- $\Omega$ R <sub>S_left_shift</sub> setting)	V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2	±15	±15	±15	%

### OCT Without Calibration Resistance Tolerance Specifications

**Table 1-9: OCT Without Calibration Resistance Tolerance Specifications for Arria V Devices**

This table lists the Arria V OCT without calibration resistance tolerance to PVT changes.

Symbol	Description	Condition (V)	ResistanceTolerance			Unit
			-I3, -C4	-I5, -C5	-C6	
25- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (25- $\Omega$ setting)	V <sub>CCIO</sub> = 3.0, 2.5	±30	±40	±40	%
25- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (25- $\Omega$ setting)	V <sub>CCIO</sub> = 1.8, 1.5	±30	±40	±40	%
25- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (25- $\Omega$ setting)	V <sub>CCIO</sub> = 1.2	±35	±50	±50	%
50- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (50- $\Omega$ setting)	V <sub>CCIO</sub> = 3.0, 2.5	±30	±40	±40	%
50- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (50- $\Omega$ setting)	V <sub>CCIO</sub> = 1.8, 1.5	±30	±40	±40	%
50- $\Omega$ R <sub>S</sub>	Internal series termination without calibration (50- $\Omega$ setting)	V <sub>CCIO</sub> = 1.2	±35	±50	±50	%
100- $\Omega$ R <sub>D</sub>	Internal differential termination (100- $\Omega$ setting)	V <sub>CCIO</sub> = 2.5	±25	±40	±40	%

Symbol/Description	Condition	Transceiver Speed Grade 4			Transceiver Speed Grade 6			Unit
		Min	Typ	Max	Min	Typ	Max	
Run length	—	—	—	200	—	—	200	UI
Programmable equalization AC and DC gain	AC gain setting = 0 to 3 <sup>(38)</sup> DC gain setting = 0 to 1	Refer to CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices and CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices diagrams.						dB

Table 1-23: Transmitter Specifications for Arria V GX and SX Devices

Symbol/Description	Condition	Transceiver Speed Grade 4			Transceiver Speed Grade 6			Unit
		Min	Typ	Max	Min	Typ	Max	
Supported I/O standards	1.5 V PCML							
Data rate	—	611	—	6553.6	611	—	3125	Mbps
V <sub>OCM</sub> (AC coupled)	—	—	650	—	—	650	—	mV
V <sub>OCM</sub> (DC coupled)	≤ 3.2Gbps <sup>(32)</sup>	670	700	730	670	700	730	mV
Differential on-chip termination resistors	85-Ω setting	—	85	—	—	85	—	Ω
	100-Ω setting	—	100	—	—	100	—	Ω
	120-Ω setting	—	120	—	—	120	—	Ω
	150-Ω setting	—	150	—	—	150	—	Ω
Intra-differential pair skew	TX V <sub>CM</sub> = 0.65 V (AC coupled) and slew rate of 15 ps	—	—	15	—	—	15	ps
Intra-transceiver block transmitter channel-to-channel skew	×6 PMA bonded mode	—	—	180	—	—	180	ps

<sup>(37)</sup> The rate match FIFO supports only up to ±300 parts per million (ppm).<sup>(38)</sup> The Quartus Prime software allows AC gain setting = 3 for design with data rate between 611 Mbps and 1.25 Gbps only.

Symbol/Description	Condition	Transceiver Speed Grade 3			Unit
		Min	Typ	Max	
$t_{LTD\_manual}^{(51)}$	—	4	—	—	$\mu s$
$t_{LTR\_LTD\_manual}^{(52)}$	—	15	—	—	$\mu s$
Programmable ppm detector <sup>(53)</sup>	—	$\pm 62.5, 100, 125, 200, 250, 300, 500, \text{ and } 1000$			ppm
Run length	—	—	—	200	UI
Programmable equalization AC and DC gain	AC gain setting = 0 to 3 <sup>(54)</sup> DC gain setting = 0 to 1	Refer to CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices and CTLE Response at Data Rates $\leq 3.25$ Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices diagrams.			

Table 1-29: Transmitter Specifications for Arria V GT and ST Devices

Symbol/Description	Condition	Transceiver Speed Grade 3			Unit
		Min	Typ	Max	
Supported I/O standards	1.5 V PCML				
Data rate (6-Gbps transceiver)	—	611	—	6553.6	Mbps
Data rate (10-Gbps transceiver)	—	0.611	—	10.3125	Gbps
V <sub>OCM</sub> (AC coupled)	—	—	650	—	mV
V <sub>OCM</sub> (DC coupled)	≤ 3.2 Gbps <sup>(48)</sup>	670	700	730	mV

<sup>(51)</sup>  $t_{LTD\_manual}$  is the time required for the receiver CDR to start recovering valid data after the `rx_is_lockedto data` signal goes high when the CDR is functioning in the manual mode.

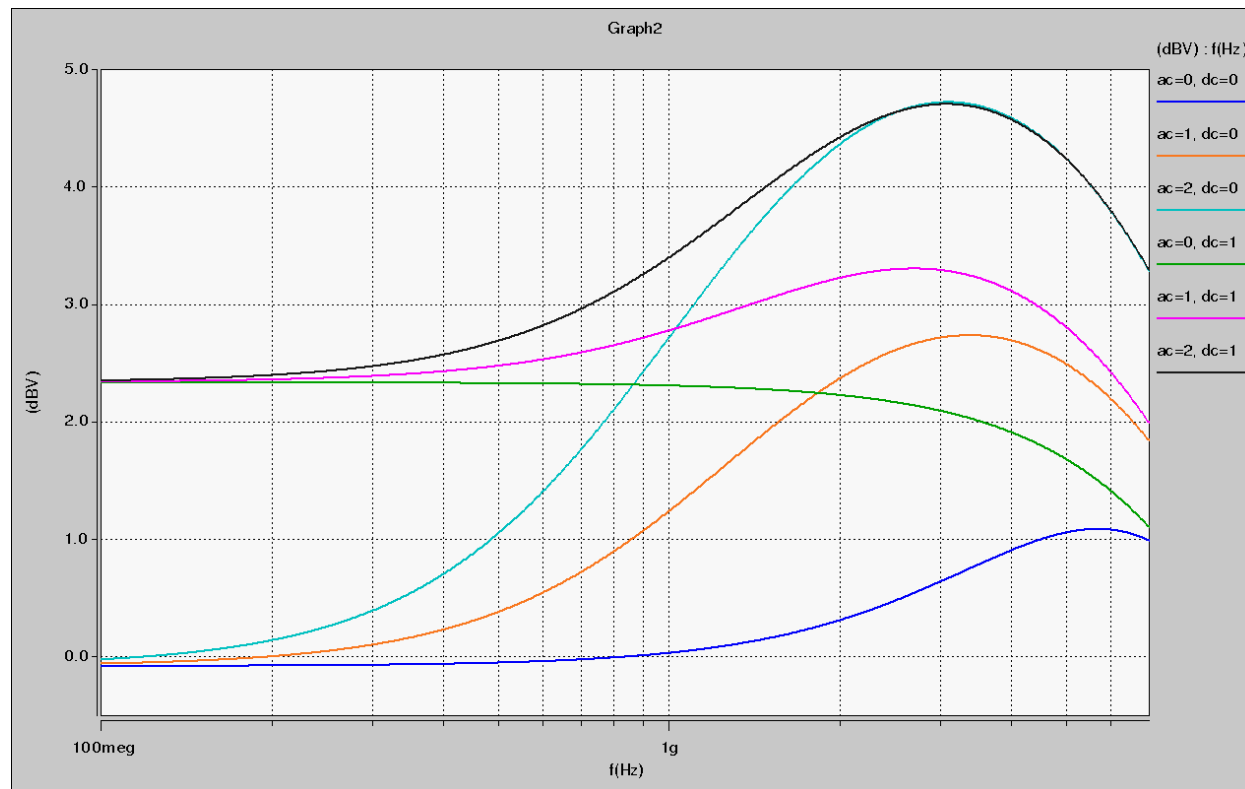
<sup>(52)</sup>  $t_{LTR\_LTD\_manual}$  is the time the receiver CDR must be kept in lock to reference (LTR) mode after the `rx_is_lockedto ref` signal goes high when the CDR is functioning in the manual mode.

<sup>(53)</sup> The rate match FIFO supports only up to  $\pm 300$  ppm.

<sup>(54)</sup> The Quartus Prime software allows AC gain setting = 3 for design with data rate between 611 Mbps and 1.25 Gbps only.

## CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain

Figure 1-2: Continuous Time-Linear Equalizer (CTLE) Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices



## CTLE Response at Data Rates $\leq 3.25$ Gbps across Supported AC Gain and DC Gain

Figure 1-3: CTLE Response at Data Rates  $\leq 3.25$  Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices

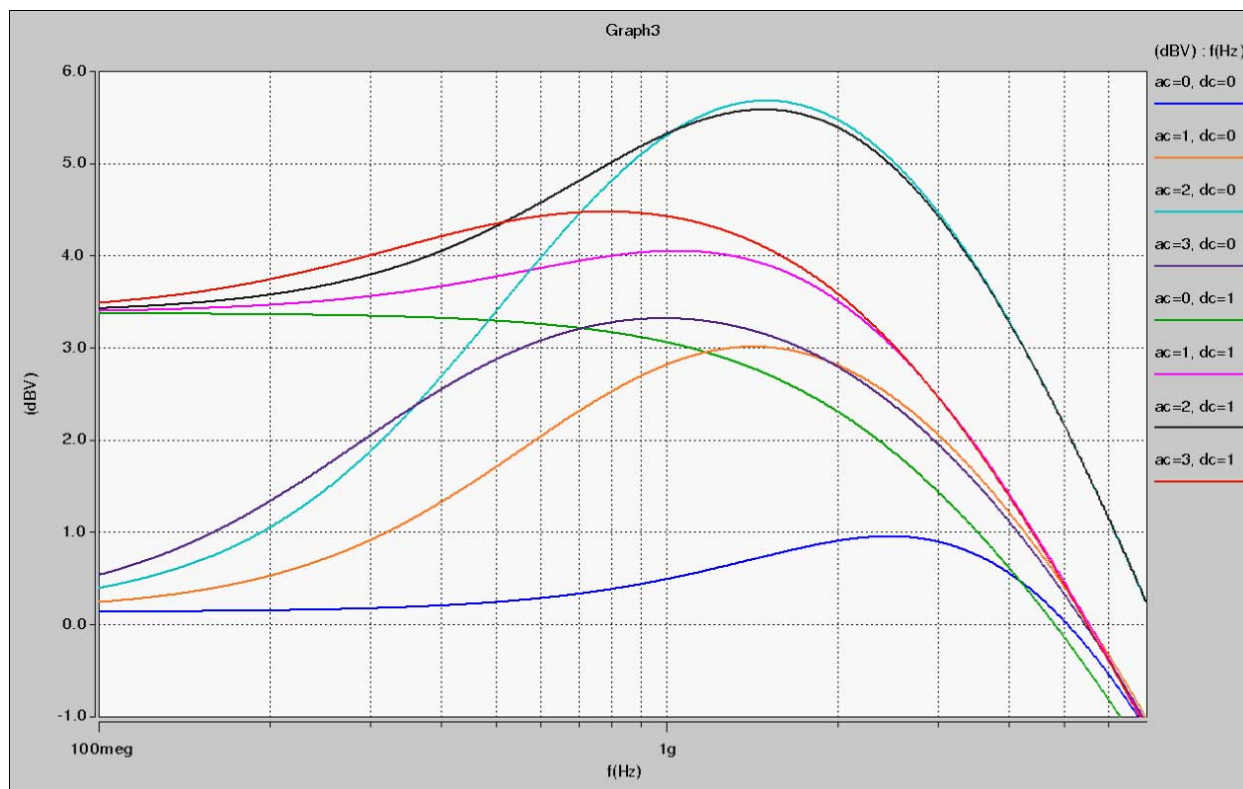


Table 1-38: Memory Block Performance Specifications for Arria V Devices

Memory	Mode	Resources Used		Performance			Unit
		ALUTs	Memory	–I3, –C4	–I5, –C5	–C6	
MLAB	Single port, all supported widths	0	1	500	450	400	MHz
	Simple dual-port, all supported widths	0	1	500	450	400	MHz
	Simple dual-port with read and write at the same address	0	1	400	350	300	MHz
	ROM, all supported width	—	—	500	450	400	MHz
M10K Block	Single-port, all supported widths	0	1	400	350	285	MHz
	Simple dual-port, all supported widths	0	1	400	350	285	MHz
	Simple dual-port with the read-during-write option set to <b>Old Data</b> , all supported widths	0	1	315	275	240	MHz
	True dual port, all supported widths	0	1	400	350	285	MHz
	ROM, all supported widths	0	1	400	350	285	MHz

## Internal Temperature Sensing Diode Specifications

Table 1-39: Internal Temperature Sensing Diode Specifications for Arria V Devices

Temperature Range	Accuracy	Offset Calibrated Option	Sampling Rate	Conversion Time	Resolution	Minimum Resolution with no Missing Codes
–40 to 100°C	±8°C	No	1 MHz	< 100 ms	8 bits	8 bits

## Periphery Performance

This section describes the periphery performance, high-speed I/O, and external memory interface.

Actual achievable frequency depends on design and system specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.



## High-Speed I/O Specifications

Table 1-40: High-Speed I/O Specifications for Arria V Devices

When  $J = 3$  to  $10$ , use the serializer/deserializer (SERDES) block. When  $J = 1$  or  $2$ , bypass the SERDES block.

For LVDS applications, you must use the PLLs in integer PLL mode.

The Arria V devices support the following output standards using true LVDS output buffer types on all I/O banks.

- True RSDS output standard with data rates of up to 360 Mbps
- True mini-LVDS output standard with data rates of up to 400 Mbps

Symbol		Condition	-I3, -C4			-I5, -C5			-C6			Unit
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{\text{HCLK\_in}}$ (input clock frequency) True Differential I/O Standards		Clock boost factor $W = 1$ to $40^{(72)}$	5	—	800	5	—	750	5	—	625	MHz
$f_{\text{HCLK\_in}}$ (input clock frequency) Single-Ended I/O Standards <sup>(73)</sup>		Clock boost factor $W = 1$ to $40^{(72)}$	5	—	625	5	—	625	5	—	500	MHz
$f_{\text{HCLK\_in}}$ (input clock frequency) Single-Ended I/O Standards <sup>(74)</sup>		Clock boost factor $W = 1$ to $40^{(72)}$	5	—	420	5	—	420	5	—	420	MHz
$f_{\text{HCLK\_OUT}}$ (output clock frequency)		—	5	—	$625^{(75)}$	5	—	$625^{(75)}$	5	—	$500^{(75)}$	MHz
Transmitter	True Differential I/O Standards - $f_{\text{HSDR}}$ (data rate)	SERDES factor $J = 3$ to $10^{(76)}$	<sup>(77)</sup>	—	1250	<sup>(77)</sup>	—	1250	<sup>(77)</sup>	—	1050	Mbps

<sup>(72)</sup> Clock boost factor ( $W$ ) is the ratio between the input data rate and the input clock rate.

<sup>(73)</sup> This applies to DPA and soft-CDR modes only.

<sup>(74)</sup> This applies to non-DPA mode only.

<sup>(75)</sup> This is achieved by using the LVDS clock network.

<sup>(76)</sup> The  $F_{\text{max}}$  specification is based on the fast clock used for serial data. The interface  $F_{\text{max}}$  is also dependent on the parallel clock domain which is design dependent and requires timing analysis.

<sup>(77)</sup> The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.

Symbol	Condition	-I3, -C4			-I5, -C5			-C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
	SERDES factor $J \geq 8^{(76)(78)}$ , LVDS TX with RX DPA	<sup>(77)</sup>	—	1600	<sup>(77)</sup>	—	1500	<sup>(77)</sup>	—	1250	Mbps
	SERDES factor $J = 1$ to 2, Uses DDR Registers	<sup>(77)</sup>	—	<sup>(79)</sup>	<sup>(77)</sup>	—	<sup>(79)</sup>	<sup>(77)</sup>	—	<sup>(79)</sup>	Mbps
Emulated Differential I/O Standards with Three External Output Resistor Network - $f_{\text{HSDR}}$ (data rate) <sup>(80)</sup>	SERDES factor $J = 4$ to $10^{(81)}$	<sup>(77)</sup>	—	945	<sup>(77)</sup>	—	945	<sup>(77)</sup>	—	945	Mbps
Emulated Differential I/O Standards with One External Output Resistor Network - $f_{\text{HSDR}}$ (data rate) <sup>(80)</sup>	SERDES factor $J = 4$ to $10^{(81)}$	<sup>(77)</sup>	—	200	<sup>(77)</sup>	—	200	<sup>(77)</sup>	—	200	Mbps
$t_{\text{x jitter}}$ - True Differential I/O Standards	Total Jitter for Data Rate 600 Mbps – 1.25 Gbps	—	—	160	—	—	160	—	—	160	ps
	Total Jitter for Data Rate < 600 Mbps	—	—	0.1	—	—	0.1	—	—	0.1	UI

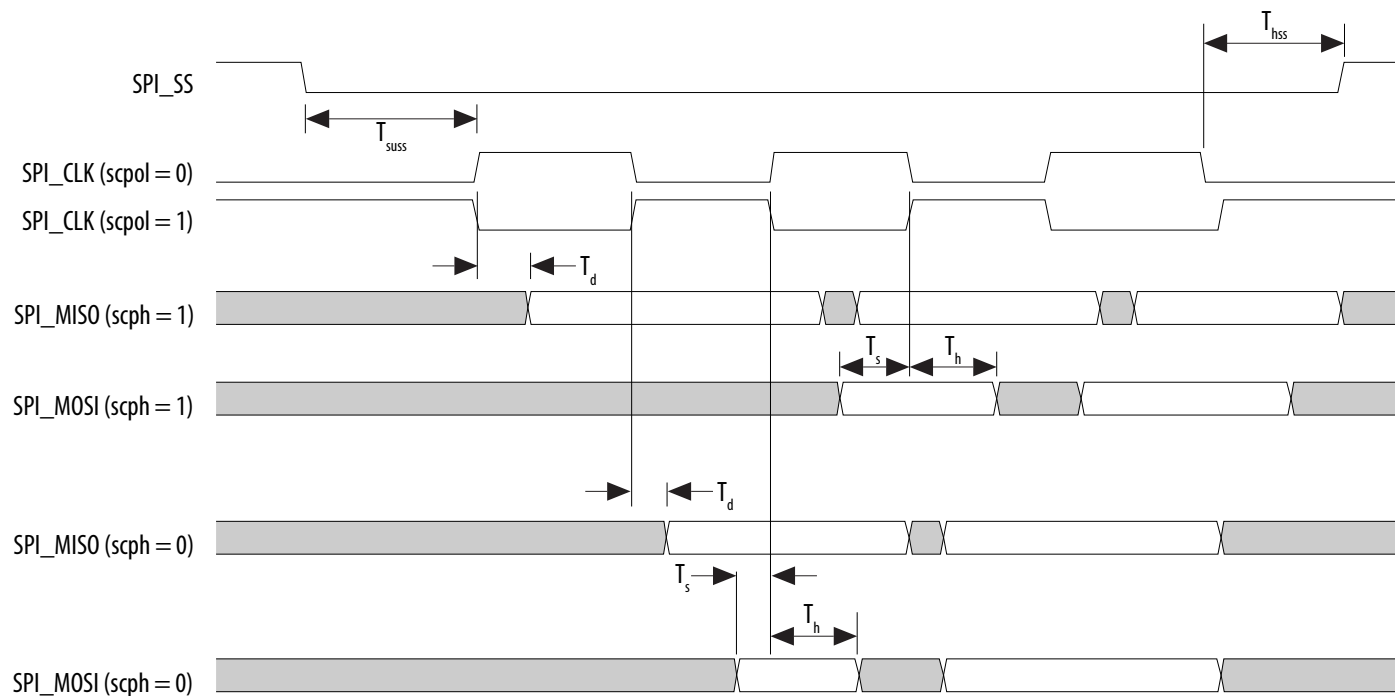
<sup>(78)</sup> The  $V_{\text{CC}}$  and  $V_{\text{CCP}}$  must be on a separate power layer and a maximum load of 5 pF for chip-to-chip interface.

<sup>(79)</sup> The maximum ideal data rate is the SERDES factor ( $J$ ) x the PLL maximum output frequency ( $f_{\text{OUT}}$ ), provided you can close the design timing and the signal integrity simulation is clean.

<sup>(80)</sup> You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine the leftover timing margin.

<sup>(81)</sup> When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

Figure 1-10: SPI Slave Timing Diagram

**Related Information****[SPI Controller, Arria V Hard Processor System Technical Reference Manual](#)**

Provides more information about rx\_sample\_delay.

**SD/MMC Timing Characteristics****Table 1-54: Secure Digital (SD)/MultiMediaCard (MMC) Timing Requirements for Arria V Devices**

After power up or cold reset, the Boot ROM uses `drvsel = 3` and `smplsel = 0` to execute the code. At the same time, the SD/MMC controller enters the Identification Phase followed by the Data Phase. During this time, the value of interface output clock `SDMMC_CLK_OUT` changes from a maximum of 400 kHz (Identification Phase) up to a maximum of 12.5 MHz (Data Phase), depending on the internal reference clock `SDMMC_CLK` and the `CSEL` setting. The value of `SDMMC_CLK` is based on the external oscillator frequency and has a maximum value of 50 MHz.

After the Boot ROM code exits and control is passed to the preloader, software can adjust the value of `drvsel` and `smp1sel` via the system manager. `drvsel` can be set from 1 to 7 and `smp1sel` can be set from 0 to 7. While the preloader is executing, the values for `SDMMC_CLK` and `SDMMC_CLK_OUT` increase to a maximum of 200 MHz and 50 MHz respectively.

The SD/MMC interface calibration support will be available in a future release of the preloader through the SoC EDS software update.

Symbol	Description	Min	Max	Unit
$T_{\text{sdmmc\_clk}}$ (internal reference clock)	SDMMC_CLK clock period (Identification mode)	20	—	ns
	SDMMC_CLK clock period (Default speed mode)	5	—	ns
	SDMMC_CLK clock period (High speed mode)	5	—	ns
$T_{\text{sdmmc\_clk\_out}}$ (interface output clock)	SDMMC_CLK_OUT clock period (Identification mode)	2500	—	ns
	SDMMC_CLK_OUT clock period (Default speed mode)	40	—	ns
	SDMMC_CLK_OUT clock period (High speed mode)	20	—	ns
$T_{\text{duty cycle}}$	SDMMC_CLK_OUT duty cycle	45	55	%
$T_d$	SDMMC_CMD/SDMMC_D output delay	$(T_{\text{sdmmc\_clk}} \times \text{drvsel})/2 - 1.23^{(87)}$	$(T_{\text{sdmmc\_clk}} \times \text{drvsel})/2 + 1.69^{(87)}$	ns
$T_{\text{su}}$	Input setup time	$1.05 - (T_{\text{sdmmc\_clk}} \times \text{smp1sel})/2^{(88)}$	—	ns
$T_h$	Input hold time	$(T_{\text{sdmmc\_clk}} \times \text{smp1sel})/2^{(88)}$	—	ns

<sup>(87)</sup> `drvsel` is the drive clock phase shift select value.

<sup>(88)</sup> `smp1sel` is the sample clock phase shift select value.

POR Delay	Minimum	Maximum	Unit
Standard	100	300	ms

**Related Information****MSEL Pin Settings**

Provides more information about POR delay based on MSEL pin settings for each configuration scheme.

## FPGA JTAG Configuration Timing

**Table 1-64: FPGA JTAG Timing Parameters and Values for Arria V Devices**

Symbol	Description	Min	Max	Unit
$t_{JCP}$	TCK clock period	30, 167 <sup>(92)</sup>	—	ns
$t_{JCH}$	TCK clock high time	14	—	ns
$t_{JCL}$	TCK clock low time	14	—	ns
$t_{JPSU}$ (TDI)	TDI JTAG port setup time	2	—	ns
$t_{JPSU}$ (TMS)	TMS JTAG port setup time	3	—	ns
$t_{JPH}$	JTAG port hold time	5	—	ns
$t_{JPCO}$	JTAG port clock to output	—	12 <sup>(93)</sup>	ns
$t_{JPZX}$	JTAG port high impedance to valid output	—	14 <sup>(93)</sup>	ns
$t_{JPXZ}$	JTAG port valid output to high impedance	—	14 <sup>(93)</sup>	ns

<sup>(92)</sup> The minimum TCK clock period is 167 ns if  $V_{CCBAT}$  is within the range 1.2 V – 1.5 V when you perform the volatile key programming.

<sup>(93)</sup> A 1-ns adder is required for each VCCIO voltage step down from 3.0 V. For example,  $t_{JPCO}$  = 13 ns if VCCIO of the TDO I/O bank = 2.5 V, or 14 ns if it equals 1.8 V.

Date	Version	Changes
January 2015	2015.01.30	<ul style="list-style-type: none"> <li>Updated the description for <math>V_{CC\_AUX\_SHARED}</math> to “HPS auxiliary power supply” in the following tables: <ul style="list-style-type: none"> <li>Absolute Maximum Ratings for Arria V Devices</li> <li>HPS Power Supply Operating Conditions for Arria V SX and ST Devices</li> </ul> </li> <li>Added statement in I/O Standard Specifications: You must perform timing closure analysis to determine the maximum achievable frequency for general purpose I/O standards.</li> <li>Updated the conditions for transceiver reference clock rise time and fall time: Measure at <math>\pm 60</math> mV of differential signal. Added a note to the conditions: REFCLK performance requires to meet transmitter REFCLK phase noise specification.</li> <li>Updated the description in Periphery Performance Specifications to mention that proper timing closure is required in design.</li> <li>Updated HPS Clock Performance main_base_clk specifications from 525 MHz (for –I3 speed grade) and 462 MHz (for –C4 speed grade) to 400 MHz.</li> <li>Updated HPS PLL VCO maximum frequency to 1,600 MHz (for –C5, –I5, and –C6 speed grades), 1,850 MHz (for –C4 speed grade), and 2,100 MHz (for –I3 speed grade).</li> <li>Changed the symbol for HPS PLL input jitter divide value from NR to N.</li> <li>Removed “Slave select pulse width (Texas Instruments SSP mode)” parameter from the following tables: <ul style="list-style-type: none"> <li>SPI Master Timing Requirements for Arria V Devices</li> <li>SPI Slave Timing Requirements for Arria V Devices</li> </ul> </li> <li>Added descriptions to USB Timing Characteristics section in HPS Specifications: PHYs that support LPM mode may not function properly with the USB controller due to a timing issue. It is recommended that designers use the MicroChip USB3300 PHY device that has been proven to be successful on the development board.</li> <li>Added HPS JTAG timing specifications.</li> <li>Updated FPGA JTAG timing specifications note as follows: A 1-ns adder is required for each <math>V_{CCIO}</math> voltage step down from 3.0 V. For example, <math>t_{jPCO} = 13</math> ns if <math>V_{CCIO}</math> of the TDO I/O bank = 2.5 V, or 14 ns if it equals 1.8 V.</li> <li>Updated the value in the <math>V_{ICM}</math> (AC Coupled) row and in note 6 from 650 mV to 750 mV in the Transceiver Specifications for Arria V GT and ST Devices table.</li> </ul>

Date	Version	Changes
June 2012	2.0	<ul style="list-style-type: none"><li>• Updated for the Quartus II software v12.0 release:</li><li>• Restructured document.</li><li>• Updated “Supply Current and Power Consumption” section.</li><li>• Updated Table 20, Table 21, Table 24, Table 25, Table 26, Table 35, Table 39, Table 43, and Table 52.</li><li>• Added Table 22, Table 23, and Table 33.</li><li>• Added Figure 1–1 and Figure 1–2.</li><li>• Added “Initialization” and “Configuration Files” sections.</li></ul>
February 2012	1.3	<ul style="list-style-type: none"><li>• Updated Table 2–1.</li><li>• Updated Transceiver-FPGA Fabric Interface rows in Table 2–20.</li><li>• Updated <math>V_{CCP}</math> description.</li></ul>
December 2011	1.2	Updated Table 2–1 and Table 2–3.
November 2011	1.1	<ul style="list-style-type: none"><li>• Updated Table 2–1, Table 2–19, Table 2–26, and Table 2–36.</li><li>• Added Table 2–5.</li><li>• Added Figure 2–4.</li></ul>
August 2011	1.0	Initial release.

## I/O Standard Specifications

The  $V_{OL}$  and  $V_{OH}$  values are valid at the corresponding  $I_{OH}$  and  $I_{OL}$ , respectively.

Table 2-16: Single-Ended I/O Standards for Arria V GZ Devices

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVC MOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

Table 2-17: Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Arria V GZ Devices

I/O Standard	$V_{CCIO}$ (V)			$V_{REF}$ (V)			$V_{TT}$ (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	$V_{REF} - 0.04$	$V_{REF}$	$V_{REF} + 0.04$
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	$V_{REF} - 0.04$	$V_{REF}$	$V_{REF} + 0.04$
SSTL-15 Class I, II	1.425	1.5	1.575	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$



Memory	Mode	Resources Used		Performance				Unit
		ALUTs	Memory	C3	C4	I3L	I4	
M20K Block	Single-port, all supported widths	0	1	650	550	500	450	MHz
	Simple dual-port, all supported widths	0	1	650	550	500	450	MHz
	Simple dual-port with the read-during-write option set to <b>Old Data</b> , all supported widths	0	1	455	400	455	400	MHz
	Simple dual-port with ECC enabled, 512 × 32	0	1	400	350	400	350	MHz
	Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32	0	1	500	450	500	450	MHz
	True dual port, all supported widths	0	1	650	550	500	450	MHz
	ROM, all supported widths	0	1	650	550	500	450	MHz

## Temperature Sensing Diode Specifications

Table 2-37: Internal Temperature Sensing Diode Specification

Temperature Range	Accuracy	Offset Calibrated Option	Sampling Rate	Conversion Time	Resolution	Minimum Resolution with no Missing Codes
-40°C to 100°C	±8°C	No	1 MHz, 500 kHz	< 100 ms	8 bits	8 bits

Table 2-38: External Temperature Sensing Diode Specifications for Arria V GZ Devices

Description	Min	Typ	Max	Unit
I <sub>bias</sub> , diode source current	8	—	200	μA
V <sub>bias</sub> , voltage across diode	0.3	—	0.9	V
Series resistance	—	—	< 1	Ω

## DLL Range Specifications

**Table 2-47: DLL Range Specifications for Arria V GZ Devices**

Arria V GZ devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Parameter	C3, I3L	C4, I4	Unit
DLL operating frequency range	300 – 890	300 – 890	MHz

## DQS Logic Block Specifications

**Table 2-48: DQS Phase Offset Delay Per Setting for Arria V GZ Devices**

The typical value equals the average of the minimum and maximum values.

The delay settings are linear with a cumulative delay variation of 40 ps for all speed grades. For example, when using a –3 speed grade and applying a 10-phase offset setting to a 90° phase shift at 400 MHz, the expected average cumulative delay is  $[625 \text{ ps} + (10 \times 11 \text{ ps}) \pm 20 \text{ ps}] = 735 \text{ ps} \pm 20 \text{ ps}$ .

Speed Grade	Min	Max	Unit
C3, I3L	8	15	ps
C4, I4	8	16	ps

**Table 2-49: DQS Phase Shift Error Specification for DLL-Delayed Clock ( $t_{\text{DQS\_PSERR}}$ ) for Arria V GZ Devices**

This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a –3 speed grade is  $\pm 84 \text{ ps}$  or  $\pm 42 \text{ ps}$ .

Number of DQS Delay Buffers	C3, I3L	C4, I4	Unit
1	30	32	ps
2	60	64	ps
3	90	96	ps

## Related Information

## Configuration, Design Security, and Remote System Upgrades in Arria V Devices

## Initialization

Table 2-61: Initialization Clock Source Option and the Maximum Frequency for Arria V GZ Devices

Initialization Clock Source	Configuration Schemes	Maximum Frequency (MHz)	Minimum Number of Clock Cycles
Internal Oscillator	AS, PS, FPP	12.5	8576
CLKUSR <sup>(222)</sup>	PS, FPP	125	
	AS	100	
DCLK	PS, FPP	125	

## Configuration Files

Use the following table to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal file (.hex) or tabular text file (.tcf) format, have different file sizes.

For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size.

<sup>(221)</sup> To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the “Initialization” section of the *Configuration, Design Security, and Remote System Upgrades in Arria V Devices* chapter.

<sup>(222)</sup> To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus II software from the **General** panel of the **Device and Pin Options** dialog box.

Term	Definition
$V_{OCM}$	Output common mode voltage—The common mode of the differential signal at the transmitter.
$V_{OD}$	Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter.
$V_{SWING}$	Differential input voltage
$V_X$	Input differential cross point voltage
$V_{OX}$	Output differential cross point voltage
W	High-speed I/O block—clock boost factor

## Document Revision History

Date	Version	Changes
February 2017	2017.02.10	<ul style="list-style-type: none"> <li>Changed the minimum value for <math>t_{CD2UMC}</math> in the "FPP Timing Parameters for Arria V GZ Devices When the DCLK-to-DATA[] Ratio is 1" table.</li> <li>Changed the minimum value for <math>t_{CD2UMC}</math> in the "FPP Timing Parameters for Arria V GZ Devices When the DCLK-to-DATA[] Ratio is &gt;1" table.</li> <li>Changed the minimum value for <math>t_{CD2UMC}</math> in the "AS Timing Parameters for AS x1 and AS x4 Configurations in Arria V GZ Devices" table.</li> <li>Changed the minimum value for <math>t_{CD2UMC}</math> in the "PS Timing Parameters for Arria V GZ Devices" table.</li> <li>Changed the minimum number of clock cycles value in the "Initialization Clock Source Option and the Maximum Frequency for Arria V GZ Devices" table.</li> </ul>

Date	Version	Changes
June 2016	2016.06.20	<ul style="list-style-type: none"><li>• Changed column heading from "Value" to "Maximum" in the "Pin Capacitance for Arria V GZ Devices" table.</li><li>• Changed the minimum supported data rate range values from "1000" to "2000" in the "ATX PLL Specifications for Arria V GZ Devices" table.</li><li>• Added the supported data rates for the following output standards using true LVDS output buffer types in the "High-Speed Clock Specifications for Arria V GZ Devices" table:<ul style="list-style-type: none"><li>• True RSDS output standard: data rates of up to 230 Mbps</li><li>• True mini-LVDS output standard: data rates of up to 340 Mbps</li></ul></li></ul>
December 2015	2015.12.16	<ul style="list-style-type: none"><li>• Removed the CDR ppm tolerance specification from the "Receiver Specifications for Arria V GZ Devices" table.</li><li>• Removed transmitter rise and fall time specifications from the "Transmitter Specifications for Arria V GZ Devices" table.</li><li>• Changed the .rbf sizes in the "Uncompressed .rbf Sizes for Arria V GZ Devices" table.</li><li>• Added a footnote to the "Transmitter High-Speed I/O Specifications for Arria V GZ Devices" table.</li></ul>
June 2015	2015.06.16	<ul style="list-style-type: none"><li>• Changed the conditions for the reference clock rise and fall time and added a note to the condition in the "Reference Clock Specifications for Arria V GZ Devices" table.</li><li>• Added a note to the "Minimum differential eye opening at receiver serial input pins" specification in the "Receiver Specifications for Arria V GZ Devices" table.</li></ul>
January 2015	2015.01.30	<ul style="list-style-type: none"><li>• Added 240-<math>\Omega</math> to the "OCT Calibration Accuracy Specifications for Arria V GZ Devices" table.</li><li>• Changed the CDR PPM tolerance spec in the "Receiver Specifications for Arria V GZ Devices" table.</li><li>• Added additional max data rate for fPLL in the "Fractional PLL Specifications for Arria V GZ Devices" table.</li></ul>